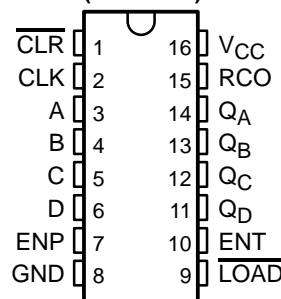


# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Synchronous Counting
- Synchronously Programmable
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection per MIL-STD-883, Method 3015

CD54AC161 ... F PACKAGE  
CD74AC161 ... E OR M PACKAGE  
(TOP VIEW)



## description/ordering information

The 'AC161 devices are 4-bit binary counters. These synchronous, presettable counters feature an internal carry look-ahead for application in high-speed counting. These devices are fully programmable; that is, they can be preset to any number between 0 and 9 or 15. Presetting is synchronous; therefore, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs.

The clear function is asynchronous. A low level at the clear ( $\overline{\text{CLR}}$ ) input sets all four of the flip-flop outputs low, regardless of the levels of the CLK, load ( $\overline{\text{LOAD}}$ ), or enable inputs.

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are ENP, ENT, and a ripple-carry output (RCO). Both ENP and ENT must be high to count, and ENT is fed forward to enable RCO. Enabling RCO produces a high-level pulse while the count is maximum (9 or 15, with  $Q_A$  high). This high-level overflow ripple-carry pulse can be used to enable successive cascaded stages. Transitions at ENP or ENT are allowed, regardless of the level of CLK.

The counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or  $\overline{\text{LOAD}}$ ) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) is dictated solely by the conditions meeting the stable setup and hold times.

## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	PDIP – E	Tube	CD74AC161E	CD74AC161E
	SOIC – M	Tube	CD74AC161M	AC161M
		Tape and reel	CD74AC161M96	
	CDIP – F	Tube	CD54AC161F3A	CD54AC161F3A

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated  
On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

FUNCTION TABLE

INPUTS						OUTPUTS		FUNCTION
CLR	CLK	ENP	ENT	LOAD	A,B,C,D	Q <sub>n</sub>	RCO	
L	X	X	X	X	X	L	L	Reset (clear)
H	↑	X	X	l	l	L	L	Parallel load
H	↑	X	X	l	h	H	Note 1	
H	↑	h	h	h	X	Count	Note 1	Count
H	X	l	X	h	X	q <sub>n</sub>	Note 1	Inhibit
H	X	X	l	h	X	q <sub>n</sub>	L	

H = high level, L = low level, X = don't care, h = high level one setup time prior to the CLK low-to-high transition, l = low level one setup time prior to the CLK low-to-high transition, q = the state of the referenced output prior to the CLK low-to-high transition, and ↑ = CLK low-to-high transition.

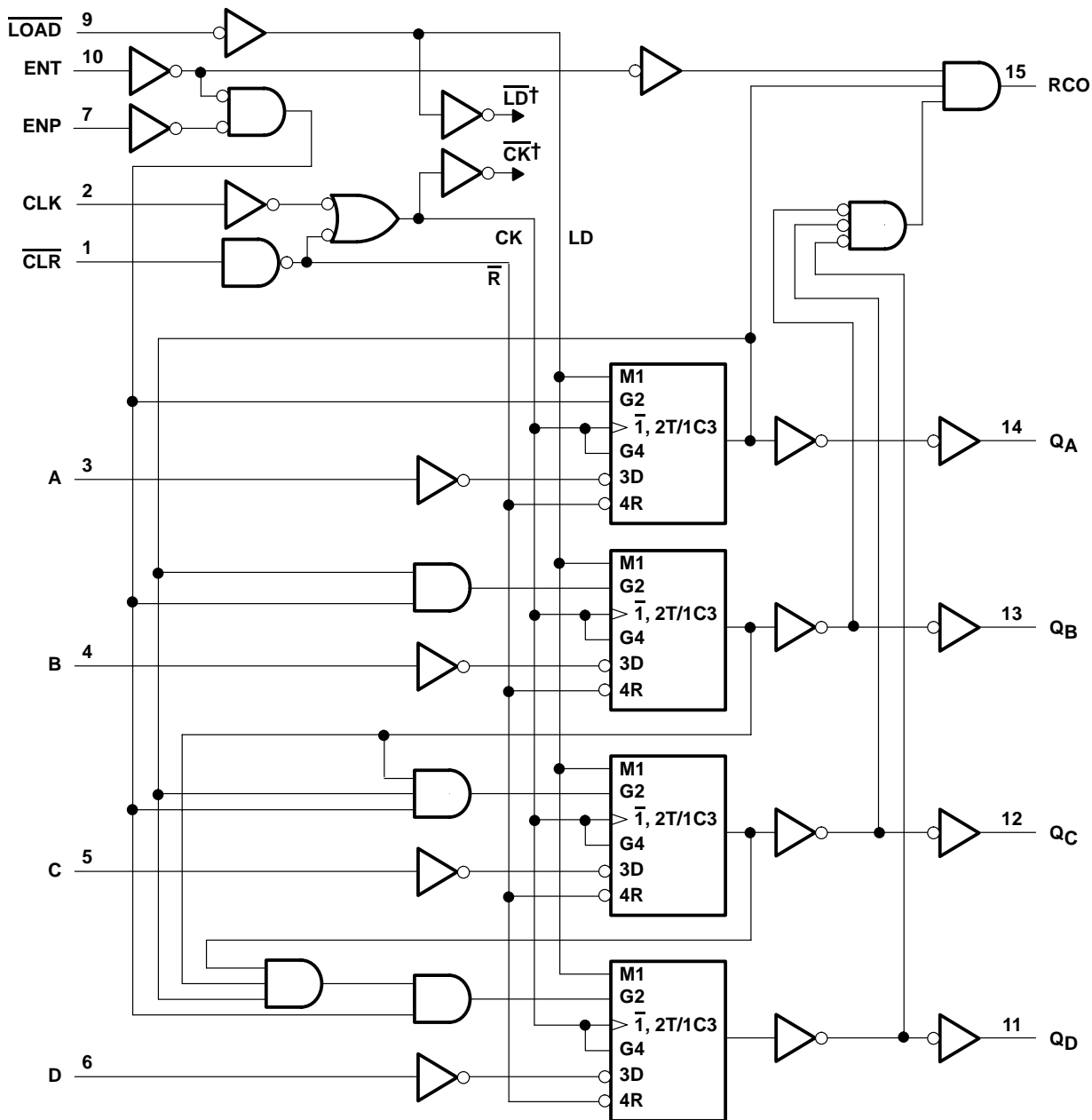
NOTE 1: The RCO output is high when ENT is high and the counter is at terminal count (HHHH).



# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

## logic diagram (positive logic)

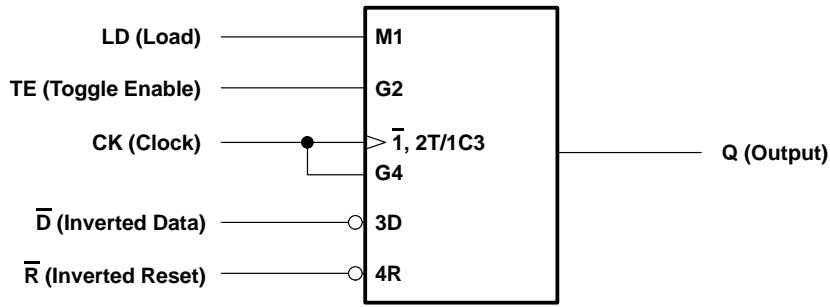


† For simplicity, routing of complementary signals  $\overline{\text{LD}}$  and  $\overline{\text{CK}}$  is not shown on this overall logic diagram. The uses of these signals are shown on the logic diagram of the D/T flip-flops.

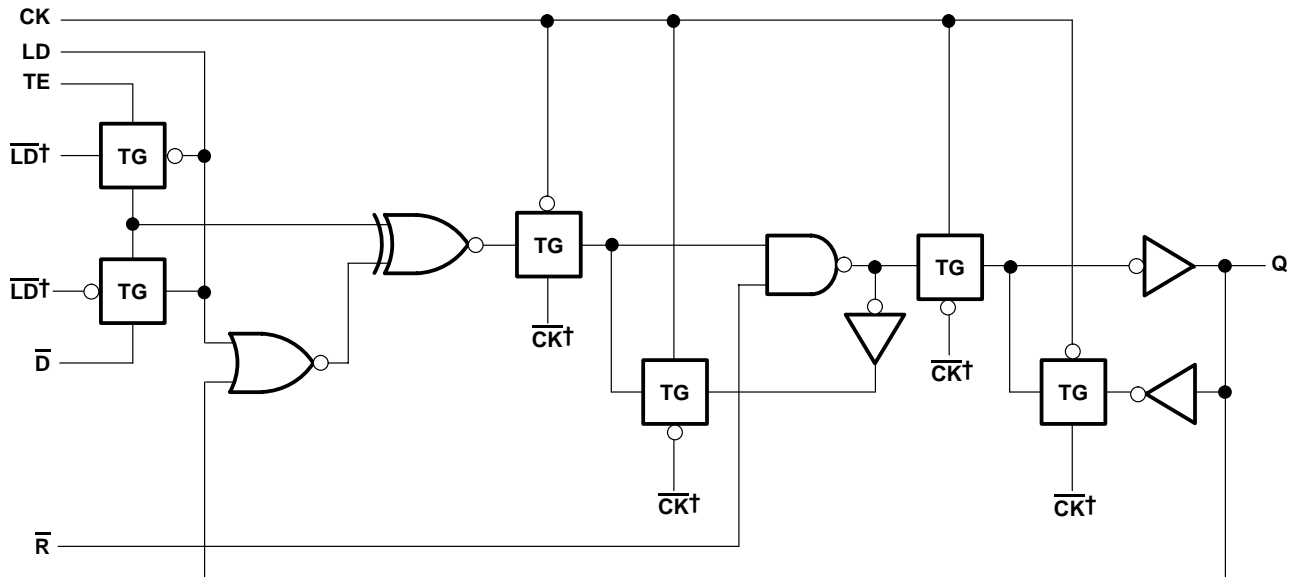
# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

## logic symbol, each D/T flip-flop



## logic diagram, each D/T flip-flop (positive logic)

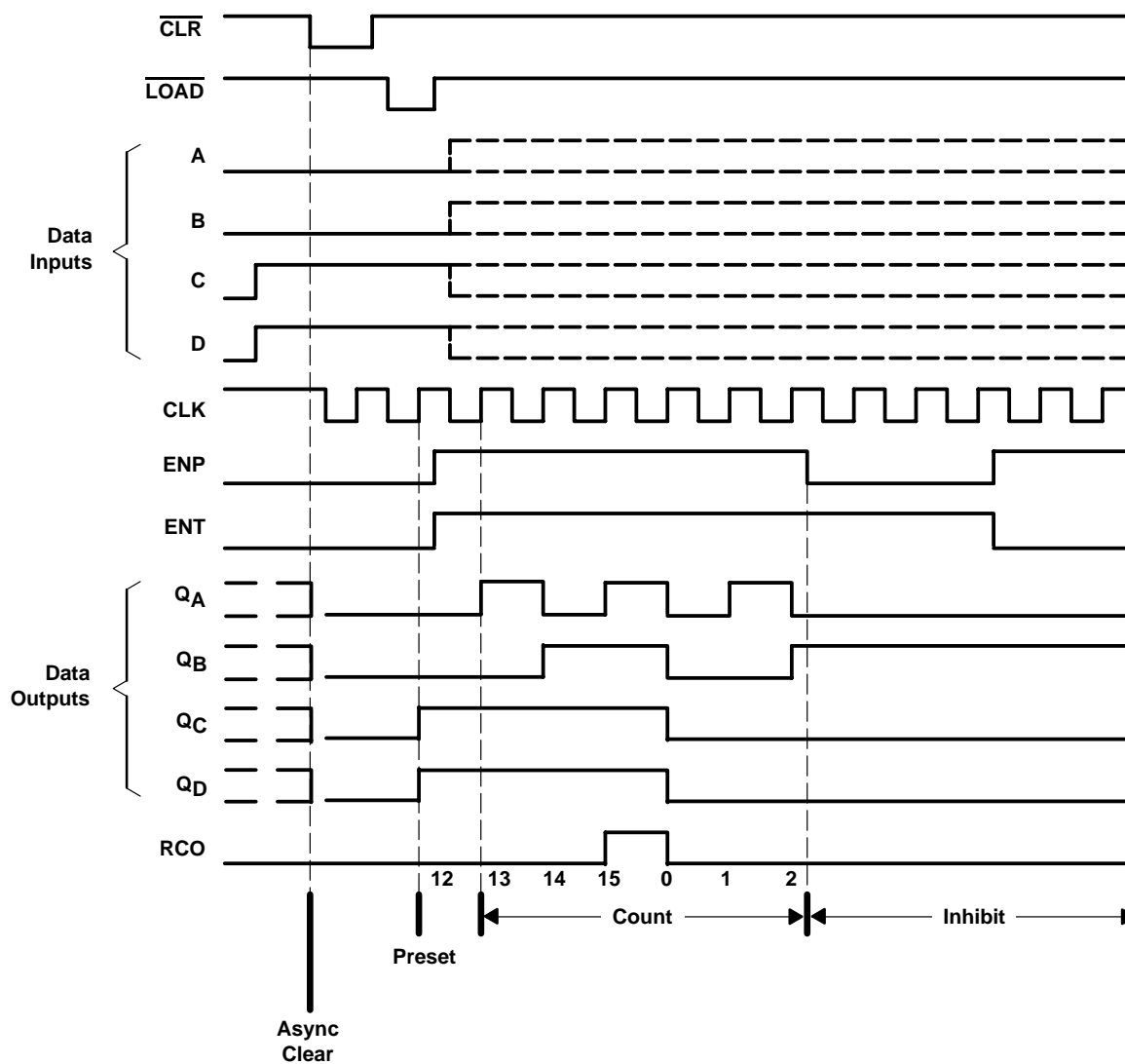


† The origins of  $\overline{LD}$  and  $\overline{CK}$  are shown in the logic diagram of the overall device.

**typical clear, preset, count, and inhibit sequence**

The following sequence is illustrated below:

1. Clear outputs to zero (asynchronous)
2. Preset to binary 12
3. Count to 13, 14, 15, 0, 1, and 2
4. Inhibit



# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$	-0.5 V to 6 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ V or $V_I > V_{CC}$ ) (see Note 2)	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ V or $V_O > V_{CC}$ ) (see Note 2)	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O > 0$ V or $V_O < V_{CC}$ )	$\pm 50$ mA
Continuous current through $V_{CC}$ or GND	$\pm 100$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): E package	67°C/W
M package	73°C/W
Storage temperature range, $T_{stg}$	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
3. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 4)

		$T_A = 25^\circ\text{C}$		$-55^\circ\text{C to } 125^\circ\text{C}$		$-40^\circ\text{C to } 85^\circ\text{C}$		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	1.5	5.5	1.5	5.5	1.5	5.5	V
$V_{IH}$	High-level input voltage	$V_{CC} = 1.5$ V		1.2		1.2		V
		$V_{CC} = 3$ V		2.1		2.1		
		$V_{CC} = 5.5$ V		3.85		3.85		
$V_{IL}$	Low-level input voltage	$V_{CC} = 1.5$ V			0.3		0.3	V
		$V_{CC} = 3$ V			0.9		0.9	
		$V_{CC} = 5.5$ V			1.65		1.65	
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	0	$V_{CC}$	V
$V_O$	Output voltage	0	$V_{CC}$	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		-24		-24		-24	mA
$I_{OL}$	Low-level output current		24		24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 1.5$ V to 3 V		50		50		ns
		$V_{CC} = 3.6$ V to 5.5 V		20		20		

NOTE 4: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C		–55°C to 125°C		–40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = –50 μA	1.5 V	1.4	1.4	1.4			V
			3 V	2.9	2.9	2.9			
			4.5 V	4.4	4.4	4.4			
		I <sub>OH</sub> = –4 mA	3 V	2.58	2.4	2.48			
		I <sub>OH</sub> = –24 mA	4.5 V	3.94	3.7	3.8			
		I <sub>OH</sub> = –50 mA <sup>†</sup>	5.5 V	–	3.85	–			
V <sub>OL</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	1.5 V	0.1	0.1	0.1		V	
			3 V	0.1	0.1	0.1			
			4.5 V	0.1	0.1	0.1			
		I <sub>OL</sub> = 12 mA	3 V	0.36	0.5	0.44			
		I <sub>OL</sub> = 24 mA	4.5 V	0.36	0.5	0.44			
		I <sub>OL</sub> = 50 mA <sup>†</sup>	5.5 V	–	1.65	–			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V	±0.1	±1	±1		μA		
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V	8	160	80		μA		
C <sub>i</sub>			10	10	10		pF		

<sup>†</sup> Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V <sub>CC</sub>	-55°C to 125°C		-40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency	1.5 V		7		8	MHz
		3.3 V ± 0.3 V		64		73	
		5 V ± 0.5 V		90		103	
t <sub>w</sub>	CLK high or low	1.5 V		69		61	ns
		3.3 V ± 0.3 V		7.7		6.8	
		5 V ± 0.5 V		5.5		4.8	
	CLR low	1.5 V		63		55	
		3.3 V ± 0.3 V		7		6.1	
		5 V ± 0.5 V		5		4.4	
t <sub>su</sub>	A, B, C, or D	1.5 V		63		55	ns
		3.3 V ± 0.3 V		7		6.1	
		5 V ± 0.5 V		5		4.4	
	LOAD	1.5 V		75		66	
		3.3 V ± 0.3 V		8.4		7.4	
		5 V ± 0.5 V		6		5.3	
t <sub>h</sub>	A, B, C, or D	1.5 V		0		0	ns
		3.3 V ± 0.3 V		0		0	
		5 V ± 0.5 V		0		0	
	ENP or ENT	1.5 V		0		0	
		3.3 V ± 0.3 V		0		0	
		5 V ± 0.5 V		0		0	
t <sub>rec</sub>	Recovery time, CLR↑ before CLK↑	1.5 V		75		66	ns
		3.3 V ± 0.3 V		8.4		7.4	
		5 V ± 0.5 V		6		5.3	





# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

switching characteristics over recommended operating free-air temperature range,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	–55°C to 125°C		–40°C to 85°C		UNIT
				MIN	MAX	MIN	MAX	
f <sub>max</sub>			1.5 V	7		8		MHz
			3.3 V ± 0.3 V	64		73		
			5 V ± 0.5 V	90		103		
t <sub>pd</sub>	CLK	RCO	1.5 V	–	209	–	190	ns
			3.3 V ± 0.3 V	6	23.4	6	21	
			5 V ± 0.5 V	4.3	16.7	4.3	15.2	
		Any Q	1.5 V	–	207	–	188	
			3.3 V ± 0.3 V	5.9	23.1	5.9	21	
			5 V ± 0.5 V	4.2	16.5	4.2	15	
	ENT	RCO	1.5 V	–	129	–	117	
			3.3 V ± 0.3 V	3.6	14.4	3.7	13.1	
			5 V ± 0.5 V	2.6	10.3	2.7	9.4	
	$\overline{\text{CLR}}$	Any Q	1.5 V	–	207	–	188	
			3.3 V ± 0.3 V	5.9	23.1	5.9	21	
			5 V ± 0.5 V	4.2	16.5	4.2	15	
		RCO	1.5 V	–	207	–	188	
			3.3 V ± 0.3 V	5.9	23.1	5.9	21	
			5 V ± 0.5 V	4.2	16.5	4.2	15	

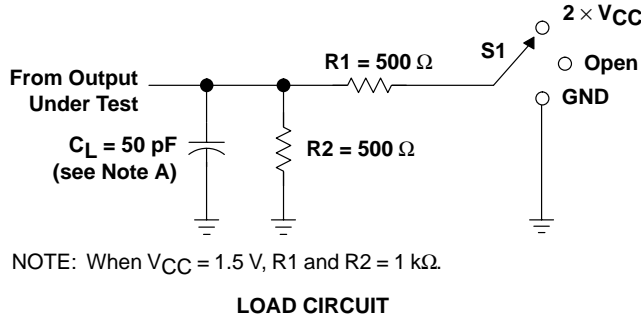
operating characteristics, T<sub>A</sub> = 25°C

PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub> Power dissipation capacitance	No load	66	pF

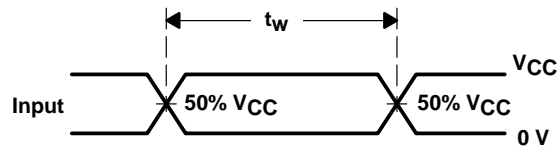
# CD54AC161, CD74AC161 4-BIT SYNCHRONOUS BINARY COUNTERS

SCHS239C – SEPTEMBER 1998 – REVISED MARCH 2003

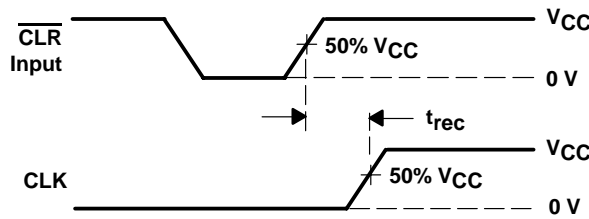
## PARAMETER MEASUREMENT INFORMATION



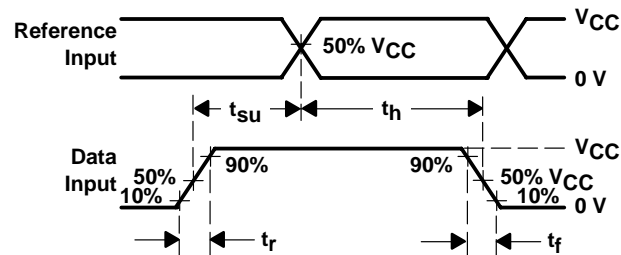
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	$2 \times V_{CC}$
$t_{PHZ}/t_{PZH}$	GND



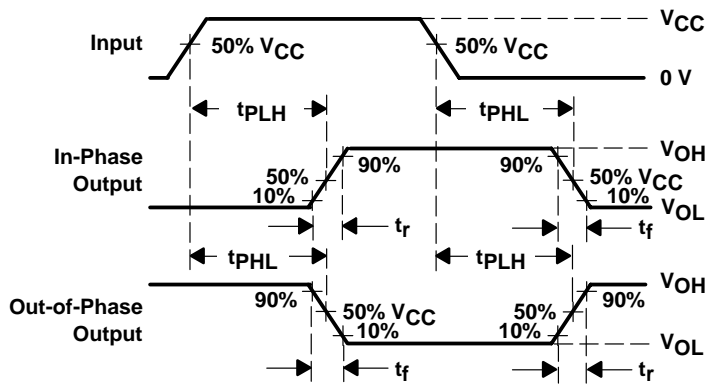
### VOLTAGE WAVEFORMS PULSE DURATION



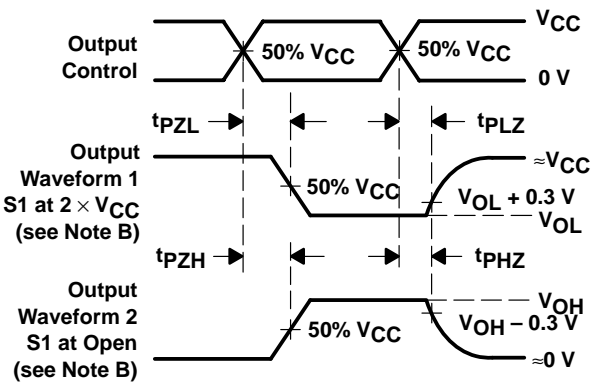
### VOLTAGE WAVEFORMS RECOVERY TIME



### VOLTAGE WAVEFORMS SETUP AND HOLD AND INPUT RISE AND FALL TIMES



### VOLTAGE WAVEFORMS PROPAGATION DELAY AND OUTPUT TRANSITION TIMES



### VOLTAGE WAVEFORMS OUTPUT ENABLE AND DISABLE TIMES

- NOTES:
- $C_L$  includes probe and test-fixture capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ . Phase relationships between waveforms are arbitrary.
  - For clock inputs,  $f_{max}$  is measured with the input duty cycle at 50%.
  - The outputs are measured one at a time with one input transition per measurement.
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



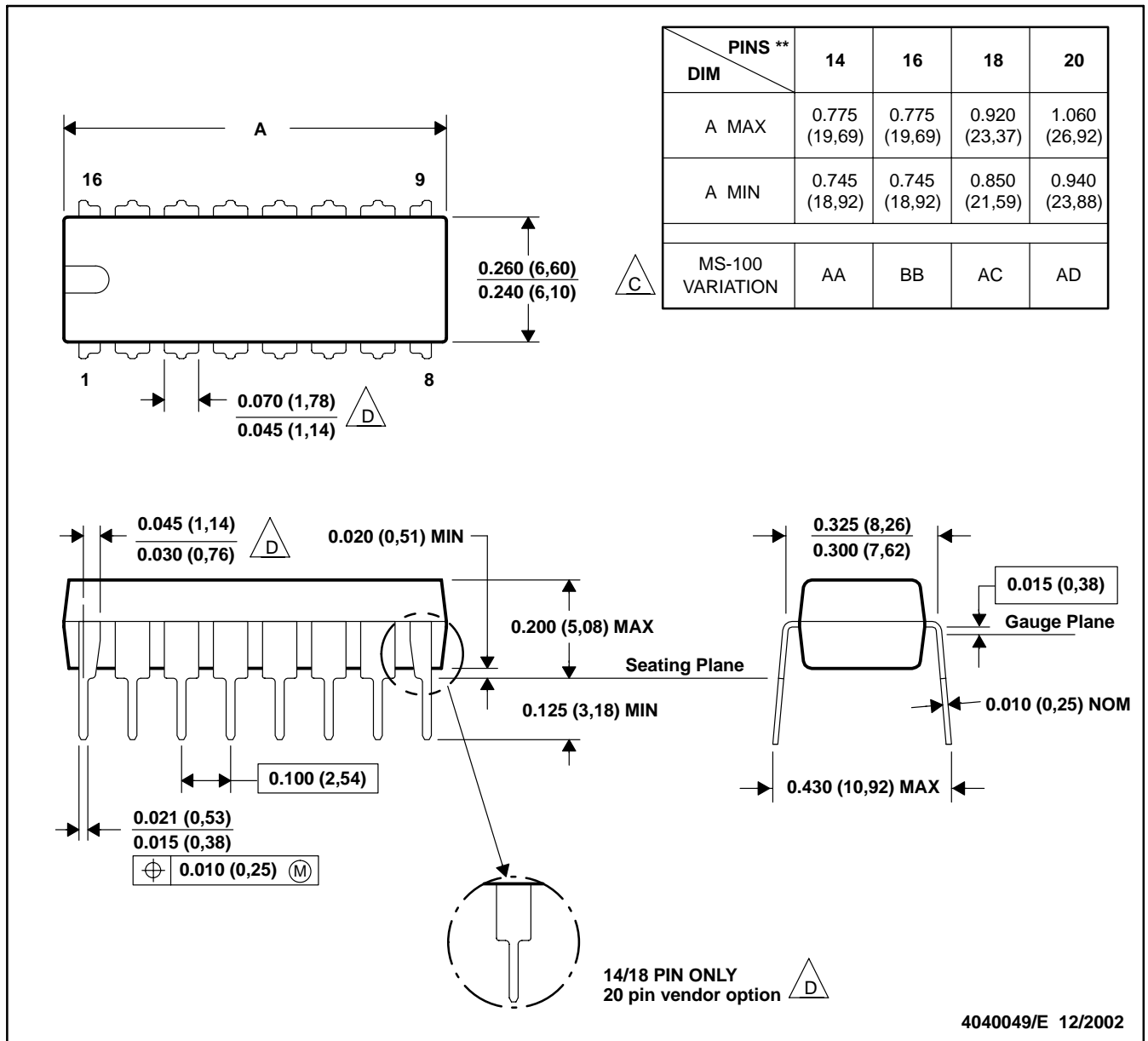
4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

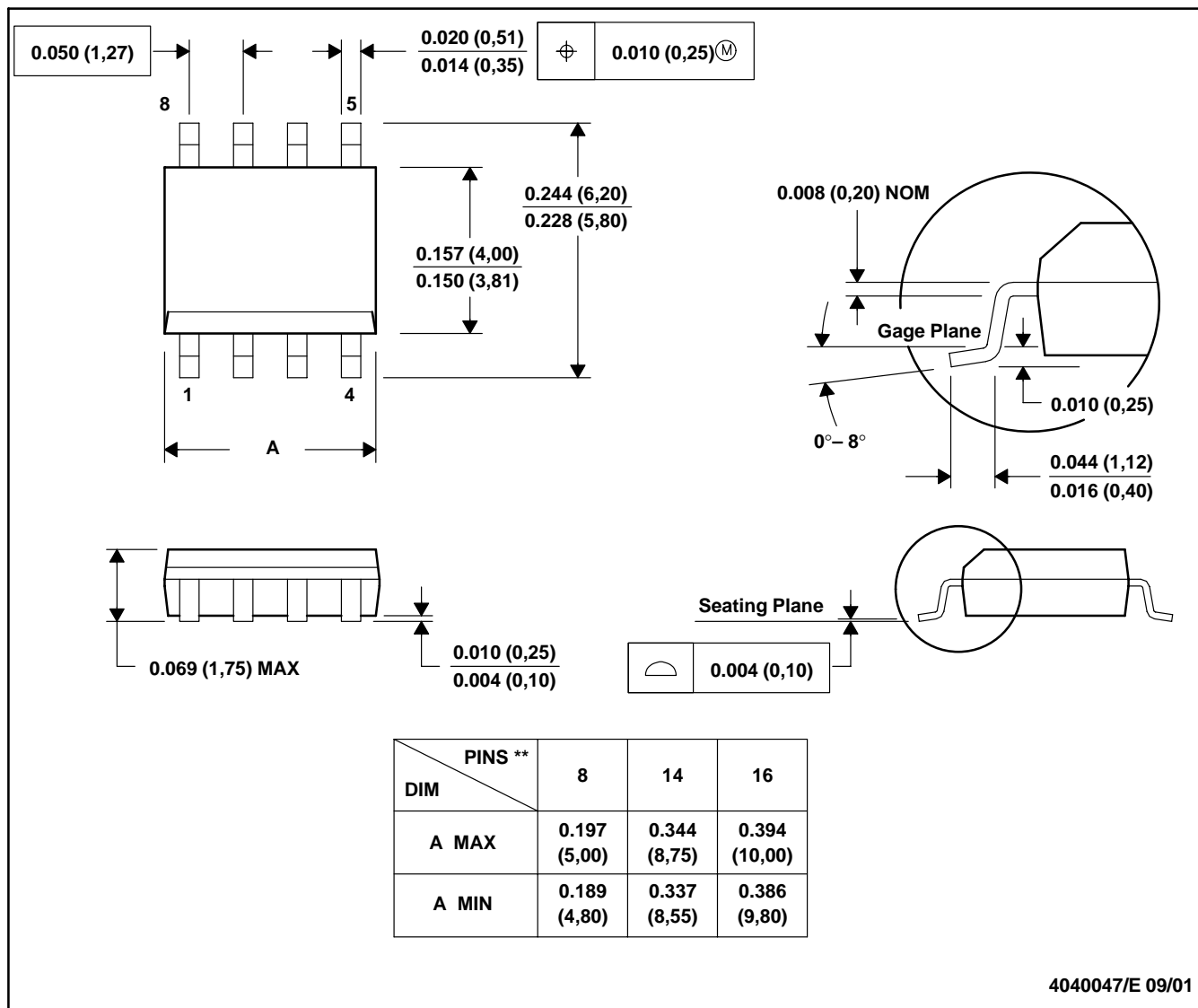


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 D The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-012

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

### Mailing Address:

Texas Instruments  
Post Office Box 655303  
Dallas, Texas 75265